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PATENT

Docket No.: ELUP0004USA

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

RECORDING COVER SHEET

22154 U.S. PTO
29/196138
122403

- 5 1. Assignor:
 A) Ching-Chi Shaw
 B) Ya-Kuang Hsiao
- 10 2. Assignee: ELUMINA TECHNOLOGY INCORPORATION
5F, No.2, Alley 2, Lane 329, Fu-Lin Rd., Taipei City, Taiwan, R.O.C
- 3. Nature of Conveyance: Assignment of patent
- 4. Reference number: Application filed herewith.
- 5. Correspondence to: Winston Hsu , Reg. No 41,526
 P.O. BOX 506
 Merrifield, VA 22116
 U.S.A.
- 15 6. Number of applications affected by this recording: 1
 Total fee: (1 x \$ 40) = \$ 40.00
 (Authorization is hereby given to charge the payment to deposit account #500801)
- 20 7. Execution date of the document to be recorded: 12/16/2003
- 8. Total number of pages including cover sheet : 3
- 9. I declare under penalty of perjury that to the best of my knowledge and belief, the information contained on this cover sheet is true and correct, and that any copy submitted herewith is a true and correct copy of the original document.

12-24-03

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Date: 12/19/2003

Winston Hsu

Winston Hsu
U.S. Patent Agent
Reg. No.:41,526

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ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

ASSIGNORS (Inventors):

Name: Ching-Chi Shaw Nationality: R.O.C.

Address: 4F-1, No. 312, Sec. 4, Jen-Ai Rd. Ta-An, Taipei City, Taiwan, R.O.C.

Name: Ya-Kuang Hsiao Nationality: R.O.C.

Address: No. 35, Lau-Shi St., Chia-I City, Taiwan, R.O.C.

Hereby sells, assigns and transfers to **ELUMINA TECHNOLOGY INCORPORATION**
(hereinafter 'Assignee'), of (Assignee address)

5F, No. 2, Alley 2, Lane 329, Fu-Lin Rd., Taipei City, Taiwan, R.O.C.

, and the successors assigns and legal representatives of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:

"Lamp with high power LED"

Which is found in :

- (a) _____ U.S. patent application executed on even date
- (b) _____ U.S. patent application executed on _____
- (c) _____ U.S. application serial no. _____
- (d) _____ patent no. _____ issued _____

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, or substitute thereof, and as to letters patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this 11/05/2003 (Date of signing).

(Type name of inventor)

Ching-Chi Shaw

Ya-Kuang Hsiao

Signature of INVENTOR

Ching Chi Shaw
Ya - Kuang Hsiao